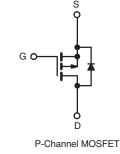
**Vishay Siliconix** 



**Power MOSFET** 

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 200				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = -10 V$	3			
Q <sub>g</sub> (Max.) (nC)	11				
Q <sub>gs</sub> (nC)	7				
Q <sub>gd</sub> (nC)	4				
Configuration	Single				





### FEATURES

- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- P-Channel
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>
- Note
- \* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2 W in a typical surface mount application.

ORDERING INFORMATION					
Package	D <sup>2</sup> PAK (TO-263)				
	SiHF9610S-GE3				
Lead (Pb)-free and Halogen-free	SiHF9610STRR-GE3				
	SiHF9610STRL-GE3				
	IRF9610SPbF				
Lead (Pb)-free	SiHF9610S-E3				
Lead (FD)-free	IRF9610STRRPbF				
	IRF9610STRLPbF				

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ess otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage			V <sub>DS</sub>	- 200	N	
Gate-Source Voltage			V <sub>GS</sub>	± 20	- V	
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>C</sub> = 25 °C		- 1.8		
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>C</sub> = 100 °C	ID	- 1	A	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	- 7				
Linear Derating Factor			0.16	W/°C		
Linear Derating Factor (PCB Mount) <sup>d</sup>		0.025	VV/ C			
Maximum Power Dissipation	D	20	W			
Maximum Power Dissipation (PCB Mount) <sup>d</sup>	T <sub>A</sub> = 25 °C		PD	3	vv	
Peak Diode Recovery dV/dt <sup>b</sup>	dV/dt	- 5	V/ns			
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C			
Soldering Recommendations (Peak Temperature)	for 1	0 s		300 <sup>c</sup>		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 5).

b.  $I_{SD} \le -1.8$  A, dl/dt  $\le 70$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C. c. 1.6 mm from case.

d. When mounted on 1" square PCB (FR-4 or G-10 material).

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FREE

Available



Vishay Siliconix

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62				
Maximum Junction-to-Ambient (PCB Mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	6.4				

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0, I <sub>D</sub> = - 250 μA	- 200	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I <sub>D</sub> = - 1 mA	-	- 0.23	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 2	-	- 4	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zaura Oasta Malka na Durin Ourmant	I <sub>DSS</sub>	V <sub>DS</sub> =	- 200 V, $V_{GS} = 0 V$	-	-	- 100	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 160	V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 0.90 A <sup>b</sup>	-	-	3	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = -	50 V, I <sub>D</sub> = - 0.90 A <sup>b</sup>	0.90	-	-	S
Dynamic							
Input Capacitance	Ciss		$V_{GS} = 0 V,$	-	170	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = -25 V,$	-	50	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	MHz, see fig. 10	-	15	-	
Total Gate Charge	Qg			-	-	11	nC
Gate-Source Charge	$Q_gs$	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 3.5 A, V <sub>DS</sub> = - 160 V, see fig. 11 and 18 <sup>b</sup>	-	-	7	
Gate-Drain Charge	Q <sub>gd</sub>			-	-	4	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = - 100 V, I <sub>D</sub> = - 0.90 A, R <sub>G</sub> = 50 Ω, R <sub>D</sub> = 110 Ω, see fig. 17 <sup>b</sup>		-	8	-	- ns
Rise Time	t <sub>r</sub>			-	15	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	1	-	
Fall Time	t <sub>f</sub>			-	8	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	nH
Internal Source Inductance	L <sub>S</sub>	package and die contact	package and center of die contact			-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 1.8	А
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 7	~
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C,	$T_{J} = 25 \ ^{\circ}C, I_{S} = -1.8 \ A, V_{GS} = 0 \ V^{b}$		-	- 5.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = - 1.8 A, dl/dt = 100 A/μs <sup>b</sup> -		-	240	360	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.7	2.6	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	Irn-on time is negligible (turn	-on is dor	ninated b	v Ls and	Ln)

### Notes

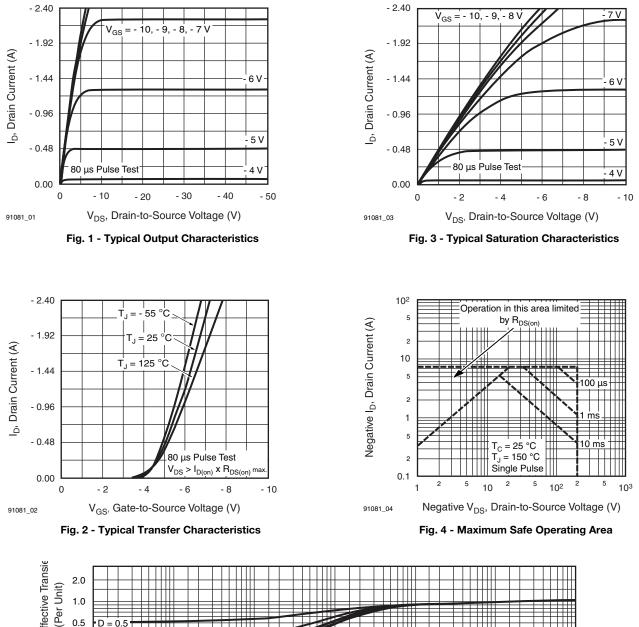
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 5).

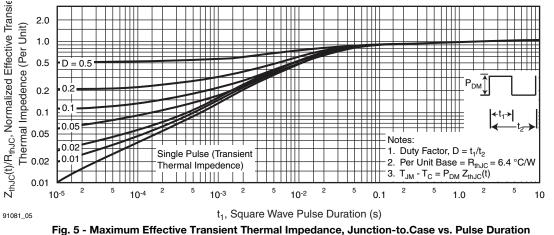
b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





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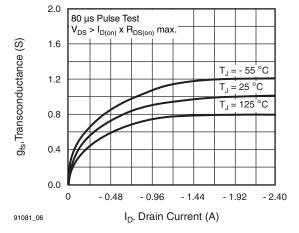


Fig. 6 - Typical Transconductance vs. Drain Current

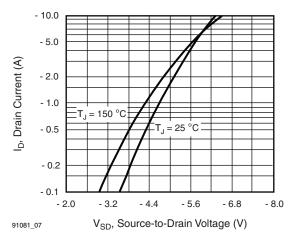


Fig. 7 - Typical Source-Drain Diode Forward Voltage

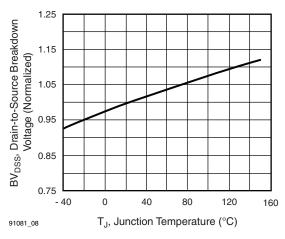


Fig. 8 - Breakdown Voltage vs. Temperature

IRF9610S, SiHF9610S

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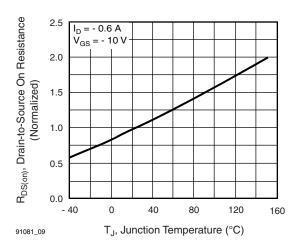


Fig. 9 - Normalized On-Resistance vs. Temperature

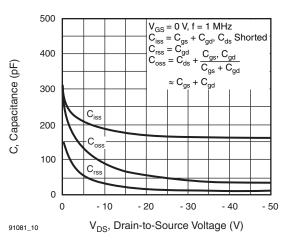


Fig. 10 - Typical Capacitance vs. Drain-to-Source Voltage

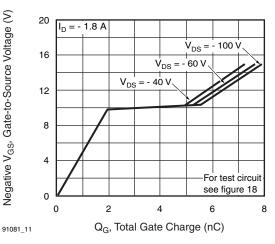


Fig. 11 - Typical Gate Charge vs. Gate-to-Source Voltage

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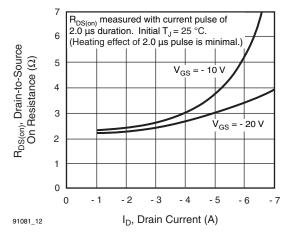


Fig. 12 - Typical On-Resistance vs. Drain Current

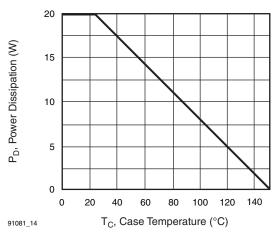


Fig. 14 - Power vs. Temperature Derating Curve

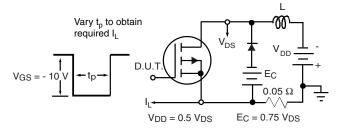


Fig. 15 - Clamped Inductive Test Circuit

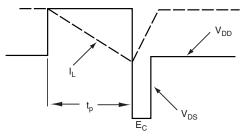


Fig. 16 - Clamped Inductive Waveforms

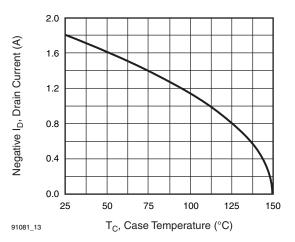


Fig. 13 - Maximum Drain Current vs. Case Temperature

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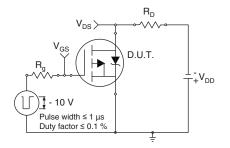


Fig. 17a - Switching Time Test Circuit

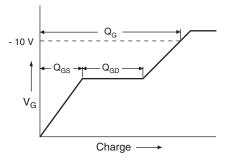


Fig. 18a - Basic Gate Charge Waveform

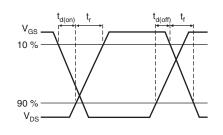


Fig. 17b - Switching Time Waveforms

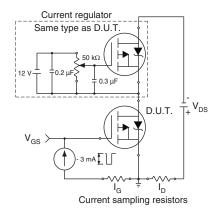
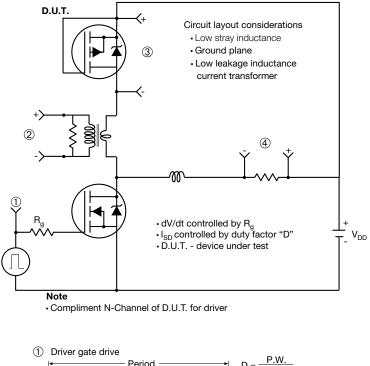


Fig. 18b - Gate Charge Test Circuit

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### Peak Diode Recovery dV/dt Test Circuit



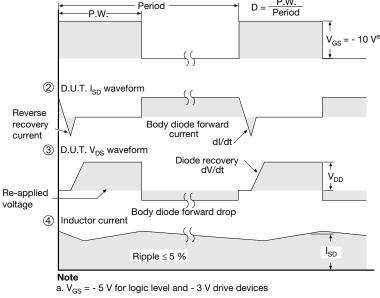


Fig. 19 - For P-Channel

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### **TO-263AB (HIGH VOLTAGE)**

∕3 ⁄4

2 x 🗗

A

н

−2 x b2 <−2 x b

⊕ 0.010 
 M A
 M B

Plating

ł

Detail A

(Datum A)

D

 $\underline{4}$ 11

		Lead tip		(c) (c) (c) (c) (c) (c) (c) (c)			$E1 \rightarrow 4$				
	MILLIMETERS		INCHES				MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
A1	0.00	0.25	0.000	0.010		Е	9.65	10.67	0.380	0.420	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b1	0.51	0.89	0.020	0.035		е	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010	BSC	
D	8.38	9.65	0.330	0.380		L4	4.78	5.28	0.188	0.208	

А

Δ

// ± 0.004 M B

b1, b3

Base metal

- Notes
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



H

B

A1

D1 4

Gauge plane

. Ŀ3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix** 

Seating plane



## **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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>>Vishay(威世)